

## DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

(X) Original    ( ) Supplemental    ( ) Substitute    ( ) PCT    ( ) DESIGN

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Title: NEGATIVE-WORKING PHOTORESISTIVE RESIN COMPOSITION AND PHOTORESISTIVE RESIN PLATE USING THE SAME

of which is described and claimed in:

- (X) the attached specification, or  
 ( ) the specification in application Serial No. \_\_\_\_\_, filed \_\_\_\_\_, and with amendments through  
 \_\_\_\_\_ (if applicable), or  
 ( ) the specification in International Application No. \_\_\_\_\_, filed \_\_\_\_\_, and as amended on  
 \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the content of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge my duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim priority benefits under Title 35, United States Code, §119 (and §172 if this application is for a Design) of any application(s) for patent or inventor's certificate listed below and have also identified below any application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
Japan	10-071513	March 5, 1998	Yes

I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

APPLICATION SERIAL NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED
09/262,077	March 4, 1999	Pending

And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Jeffrey Nolton, Reg. No. 25,408; Warren M. Cheek, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; and Charles R. Watts, Reg. No. 33,142, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., jointly and severally, attorneys to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.

I hereby authorize the U.S. attorneys named herein to accept and follow instructions from HASEGAWA & ASSOCIATES as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

Send Correspondence to

Direct Telephone Calls to:

WENDEROTH, LIND & PONACK, L.L.P.  
2033 K Street, N.W., Suite 800  
Washington, D.C. 20006

WENDEROTH, LIND & PONACK, L.L.P.  
Area Code (202) 721-8200

Direct Facsimile Messages to:  
Area Code (202) 721-8250

<b>Full Name of First Inventor</b>	<b>FAMILY NAME</b> <b>TAKANASHI</b>	<b>FIRST GIVEN NAME</b> <b>Hiroshi</b>	<b>SECOND GIVEN NAME</b>	
<b>Residence &amp; Citizenship</b>	<b>CITY</b> <b>Tokyo</b>	<b>STATE OR COUNTRY</b> <b>Japan</b>	<b>COUNTRY OF CITIZENSHIP</b> <b>Japan</b>	
<b>Post Office Address</b>	<b>ADDRESS</b> <b>24-11, Nishirokugo 1-chome, Ota-ku, Tokyo, Japan</b>	<b>CITY</b>	<b>STATE OR COUNTRY</b>	<b>ZIP CODE</b>
<b>Full Name of Second Inventor</b>	<b>FAMILY NAME</b> <b>KUDO</b>	<b>FIRST GIVEN NAME</b> <b>Tomoya</b>	<b>SECOND GIVEN NAME</b>	
<b>Residence &amp; Citizenship</b>	<b>CITY</b> <b>Kanagawa-ken</b>	<b>STATE OR COUNTRY</b> <b>Japan</b>	<b>COUNTRY OF CITIZENSHIP</b> <b>Japan</b>	
<b>Post Office Address</b>	<b>ADDRESS</b> <b>15-3, Ichinomiya 9-chome, Samukawamachi, Koza-gun, Kanagawa-ken, Japan</b>	<b>CITY</b>	<b>STATE OR COUNTRY</b>	<b>ZIP CODE</b>
<b>Full Name of Third Inventor</b>	<b>FAMILY NAME</b>	<b>FIRST GIVEN NAME</b>	<b>SECOND GIVEN NAME</b>	
<b>Residence &amp; Citizenship</b>	<b>CITY</b>	<b>STATE OR COUNTRY</b>	<b>COUNTRY OF CITIZENSHIP</b>	
<b>Post Office Address</b>	<b>ADDRESS</b>	<b>CITY</b>	<b>STATE OR COUNTRY</b>	<b>ZIP CODE</b>
<b>Full Name of Fourth Inventor</b>	<b>FAMILY NAME</b>	<b>FIRST GIVEN NAME</b>	<b>SECOND GIVEN NAME</b>	
<b>Residence &amp; Citizenship</b>	<b>CITY</b>	<b>STATE OR COUNTRY</b>	<b>COUNTRY OF CITIZENSHIP</b>	
<b>Post Office Address</b>	<b>ADDRESS</b>	<b>CITY</b>	<b>STATE OR COUNTRY</b>	<b>ZIP CODE</b>
<b>Full Name of Fifth Inventor</b>	<b>FAMILY NAME</b>	<b>FIRST GIVEN NAME</b>	<b>SECOND GIVEN NAME</b>	
<b>Residence &amp; Citizenship</b>	<b>CITY</b>	<b>STATE OR COUNTRY</b>	<b>COUNTRY OF CITIZENSHIP</b>	
<b>Post Office Address</b>	<b>ADDRESS</b>	<b>CITY</b>	<b>STATE OR COUNTRY</b>	<b>ZIP CODE</b>
<b>Full Name of Sixth Inventor</b>	<b>FAMILY NAME</b>	<b>FIRST GIVEN NAME</b>	<b>SECOND GIVEN NAME</b>	
<b>Residence &amp; Citizenship</b>	<b>CITY</b>	<b>STATE OR COUNTRY</b>	<b>COUNTRY OF CITIZENSHIP</b>	
<b>Post Office Address</b>	<b>ADDRESS</b>	<b>CITY</b>	<b>STATE OR COUNTRY</b>	<b>ZIP CODE</b>

I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

1st Inventor Hiroshi Takanashi Date November 27, 2000  
Hiroshi TAKANASHI

2nd Inventor Tomoya Kudo Date November 27, 2000  
Tomoya KUDO

3rd Inventor \_\_\_\_\_ Date \_\_\_\_\_

4th Inventor \_\_\_\_\_ Date \_\_\_\_\_

5th Inventor \_\_\_\_\_ Date \_\_\_\_\_

6th Inventor \_\_\_\_\_ Date \_\_\_\_\_

The above application may be more particularly identified as follows:

U.S. Application Serial No. \_\_\_\_\_ Filing Date \_\_\_\_\_

Applicant Reference Number FP/TOK-16-US/YH Atty Docket No. 01497/FP/TOK-16-US/YH 99-0224A

Title of Invention NEGATIVE-WORKING PHOTORESISTIVE RESIN COMPOSITION AND PHOTORESISTIVE RESIN PLATE USING THE SAME